

Description

The BSC093N04LSG uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. Thisdevice is suitable for use as a Battery protection or in other Switching application.

General Features

V_{DS} = 40V I_D =60 A

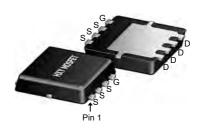
 $R_{DS(ON)} < 8.5 \text{m}\Omega @ V_{GS}=10V$

Application

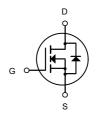
Battery protection

Load switch

Uninterruptible power supply



DFN5X6-8L



N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
BSC093N04LS	DFN5X6-8L	HXY MOSFET	5000

Absolute Maximum Ratings (T_C=25[°]Cunless otherwise noted)

Symbol	Parameter	Rating	Units	
V _D s	Drain-Source Voltage	V		
Vgs	Gate-Source Voltage ±20			
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹ 60			
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	35	A	
Ідм	Pulsed Drain Current ²	105	А	
EAS	Single Pulse Avalanche Energy³	48	mJ	
las	Avalanche Current	35	А	
P _D @T _C =25°C	Total Power Dissipation ⁴	Total Power Dissipation ⁴ 39		
Тѕтс	Storage Temperature Range -55 to 150		°C	
TJ	Operating Junction Temperature Range -55 to 150		°C	
Reja	R _{BJA} Thermal Resistance Junction-ambient (Steady State) ¹ 62		°C/W	
Rejc	ReJc Thermal Resistance Junction-Case ¹		°C/W	

N-Channel Enhancement Mode MOSFET

Electrical Characteristics (T = 25 , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	40			V	
RDS(ON)		V _{GS} =10V , I _D =10A		7	8.5	mΩ	
	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =5A		10	15		
VGS(th)	Gate Threshold Voltage V _{GS} =V _{DS} , I _D =250uA		1.0	1.7	3	V	
	Drain-Source Leakage Current	V _{DS} =32V , V _{GS} =0V , T _J =25°C			1	- uA	
Ipss		V _{DS} =32V , V _{GS} =0V , T _J =55°C			5		
Igss	Gate-Source Leakage Current	Gate-Source Leakage Current V _{GS} =±20V , V _{DS} =0V			±100	nA	
gfs	Forward Transconductance	V _{DS} =10V , I _D =5A		27		S	
Qg	Total Gate Charge (4.5V)			20			
Qgs	Gate-Source Charge	V _{DS} =20V , V _{GS} =4.5V , I _D =10A		5.8		nC	
Qgd	Gate-Drain Charge			9.5			
Td(on)	Turn-On Delay Time			15.2			
Tr	Rise Time	V _{DD} =15V , V _{GS} =10V		8.8			
Td(off)	Turn-Off Delay Time			74		ns	
Tf	Fall Time	ID- IA		7			
Ciss	Input Capacitance			690			
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		193		pF	
Crss	Reverse Transfer Capacitance			38			
ls	Continuous Source Current ^{1,5}	V _G =V _D =0V , Force Current			70	Α	
VsD	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1	V	

Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width \leqq 300us , duty cycle \leqq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V,L=0.1mH,I_{AS}=47A
- 4.The power dissipation is limited by 150 $^{\circ}\mathrm{C}$ junction temperature
- 5.The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

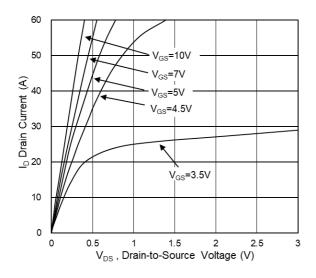


Fig.1 Typical Output Characteristics

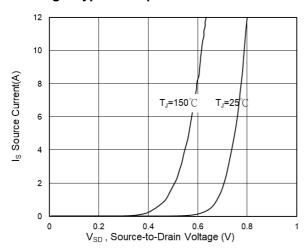


Fig.3 Source Drain Forward Characteristics

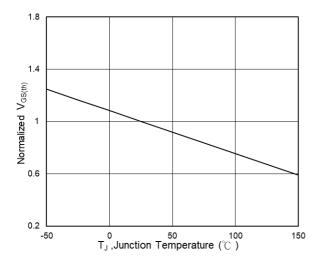


Fig.5 Normalized $V_{\text{GS(th)}}$ vs T_{J}

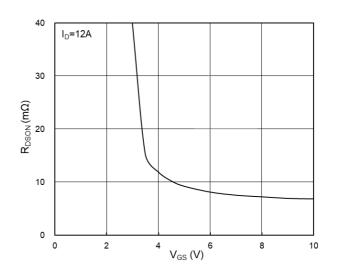


Fig.2 On-Resistance vs G-S Voltage

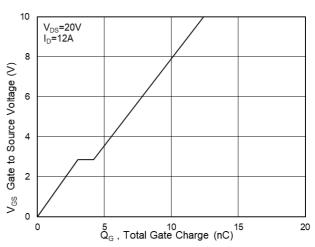


Fig.4 Gate-Charge Characteristics

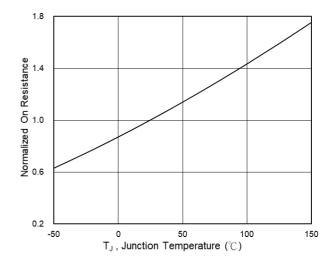
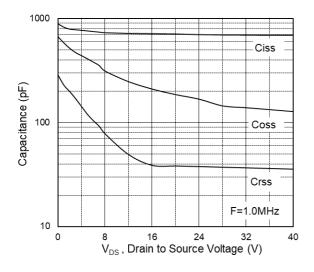


Fig.6 Normalized R_{DSON} vs T_J



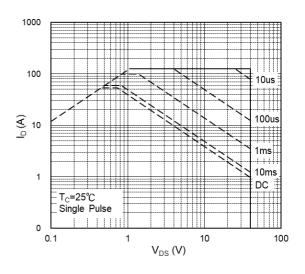
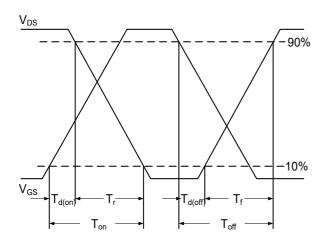
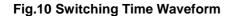


Fig.7 Capacitance Fig.8 Safe Operating Area Normalized Thermal Response (Reuc) DUTY=0.5 0.3 0.1 0.05 0.02 0.01 $D = T_{ON}/T$ SINGLE PUL T_J peak = $T_C + P_{DM} x R_{\theta JC}$ 0.01 0.00001 0.0001 0.001 0.01 0.1 t, Pulse Width (s)

Fig.9 Normalized Maximum Transient Thermal Impedance





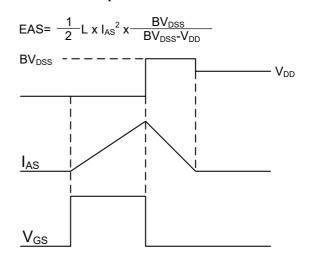
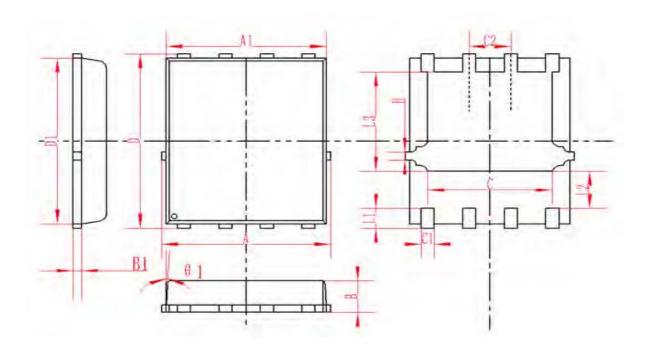


Fig.11 Unclamped Inductive Waveform

DFN5X6-8L Package Information



SYMBOL	MM		INCH				
	MIN	NOM	MAX	MIN	NOM	MAX	
А	4.95	5	5.05	0.195	0.197	0.199	
A1	4.82	4.9	4.98	0.190	0.193	0.196	
D	5.98	6	6.02	0.235	0.236	0.237	
D1	5.67	5.75	5.83	0.223	0.226	0.230	
В	0.9	0.95	1	0.035	0.037	0.039	
B1	0.254REF		0.010REF				
С	3.95	4	4.05	0.156	0.157	0.159	
C1	0.35	0.4	0.45	0.014	0.016	0.018	
C2	1.27TYP		0.5TYP				
θ1	8°	10°	12°	8°	10°	12°	
L1	0.63	0.64	0.65	0.025	0.025	0.026	
L2	1.2	1.3	1.4	0.047	0.051	0.055	
L3	3.415	3.42	3.425	0.134	0.135	0.135	
Н	0.24	0.25	0.26	0.009	0.010	0.010	



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BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR
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